# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	<b>Execution Date</b>
CHING-KAI CHIU	04/17/2021

### **RECEIVING PARTY DATA**

Name:	UNIVERSITY OF CHINESE ACADEMY OF SCIENCES	
Street Address:	NO. 19A YUQUAN ROAD	
Internal Address:	HAIDIAN DISTRICT	
City:	BEIJING	
State/Country:	CHINA	

## **PROPERTY NUMBERS Total: 2**

Property Type	Number
Application Number:	63062178
Application Number:	17396151

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	166228.00038	
NAME OF SUBMITTER:	KAITLYN M. SLATER	
SIGNATURE:	/Kaitlyn M. Slater/	
DATE SIGNED:	07/31/2023	

**Total Attachments: 1** 

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Sciences#page1.tif

PATENT REEL: 064440 FRAME: 0557

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#### ASSIGNMENT

WHEREAS, the undersigned has made certain inventions which are described in an application for Letters Patent of the United States entitled ROBUSTLY EMULATING VORTEX MAJORANA BRAIDING IN A FINITE TIME, filed as U.S. Provisional Application 63/062,178 on August 6, 2020; and

WHEREAS, **UNIVERSITY OF CHINESE ACADEMY OF SCIENCES** (hereafter referred to as "Company"), a corporation of **Beijing**, **China** having a place of business at **No. 19A YuQuan Road**, **Haidian Distrcit**, **Beijing**, **China**, is desirous of acquiring the entire interest in said inventions throughout the United States of America and the territories thereof, for all other countries and under all international agreements,

NOW, THEREFORE, for and in consideration of One Dollar (\$1.00), and other good and valuable consideration, receipt whereof is hereby acknowledged, the undersigned hereby sell(s), assign(s) and transfer(s) unto said Company, its successors and assigns, the entire right, title and interest throughout the United States of America and the territories thereof, for all foreign countries and under all international agreements in and to said inventions, the aforesaid application, all other applications hereafter filed in the United States, in any other country, or under any international agreement based in whole or in part on said inventions, and all Letters Patents granted upon said applications by the United States, by any other country or under any international agreement, and do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to said Company.

The undersigned further grant to said Company, its successors and assigns, the right to claim for any of said applications the full benefits and priority rights of any international agreement between the United States and any foreign country or countries of between any other countries. The undersigned hereby warrant(s) that they/(s)he have/has the full right to make the conveyance herein, and hereby covenant(s) that the heirs, legal representatives and assigns of the undersigned, will when requested, communicate to said Company, its representatives, successors and assigns, all facts known respecting said inventions, execute all divisional, continuing, reissue, reexamination and foreign or international applications, together with individual assignment therefore, make all rightful oaths, sign all lawful papers, testify in any legal proceeding and generally do everything possible to aid said Company, its successors and assigns, in the obtaining of Letters Patent.

IN TESTIMONY WHEREOF, the undersigned have hereunto executed this assignment at the location and on the date indicated below.

Ching-Kai Chil	04.17.2021
Name: Ching-Kai Chiu	Date
Yen-Tzu Liu	04.17.2021
Witness Name	Date
Vitness Signature	

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